

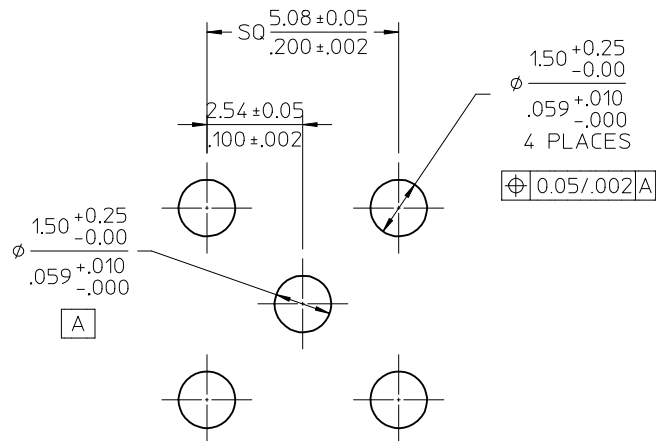
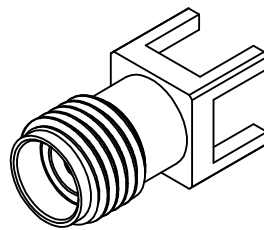
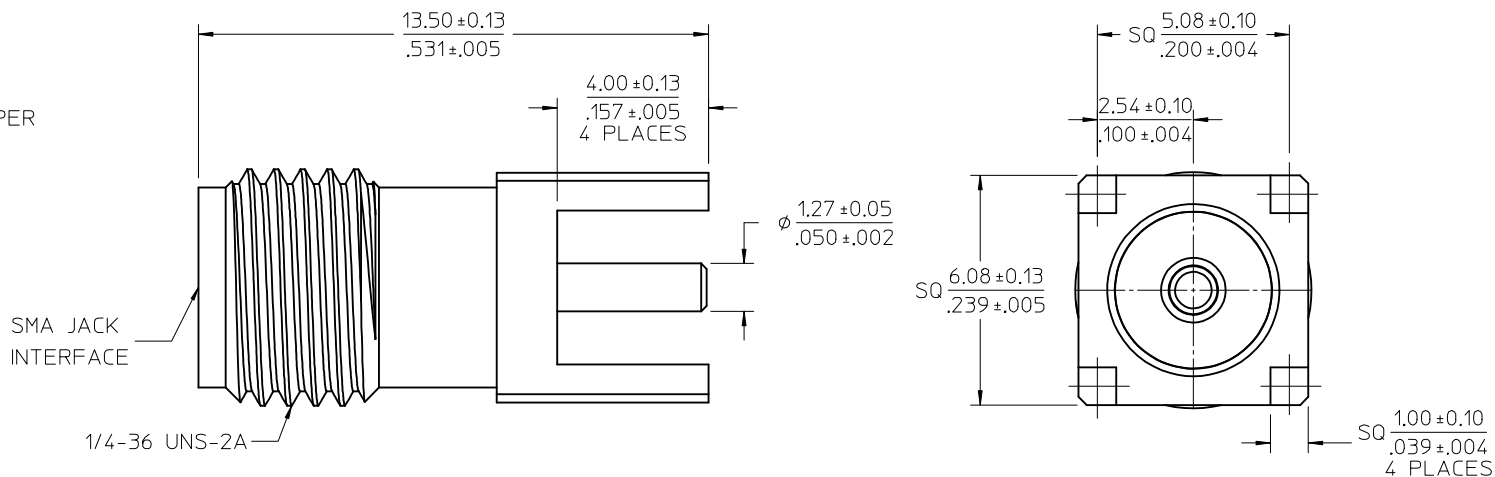
MATERIALS AND FINISHES

BODY BRASS
PLATED GOLD

CENTER CONTACT BERYLLIUM COPPER
PLATED GOLD

INSULATOR TEFLON

WILL WITHSTAND REFLOW
TEMPERATURE OF
265°C ± 5°C



73251-3141	73391-0060 BY TRAY 20 CAVITIES
73251-3140	73391-0060 SINGLE BAG
73391-0060	BY TRAY 80 CAVITIES
PART NO.	DESCRIPTION

PS-89675-3460	ELEC/MECH PERFORMANCE
SPECIFICATION	DESCRIPTION

CHG: ADDED TOLERANCE FOR EACH DIMENSION PER RF13-E014 EC NO: URF2013-0079 DRWR:YEH 2012/08/09 CHKD: APPR:HUANG 2012/08/21 REV:	QUALITY SYMBOLS ∇=0 ∇=0 ∇=0	GENERAL TOLERANCES (UNLESS SPECIFIED) <table border="1"> <tr> <th></th> <th>mm</th> <th>INCH</th> </tr> <tr> <td>4 PLACES</td> <td>± .005</td> <td>± .0002</td> </tr> <tr> <td>3 PLACES</td> <td>± .004</td> <td>± .00015</td> </tr> <tr> <td>2 PLACES</td> <td>± .003</td> <td>± .0001</td> </tr> <tr> <td>1 PLACE</td> <td>± .002</td> <td>± .00005</td> </tr> <tr> <td>0 PLACE</td> <td>± .001</td> <td>± .00002</td> </tr> </table> ANGULAR ± 2 ° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		mm	INCH	4 PLACES	± .005	± .0002	3 PLACES	± .004	± .00015	2 PLACES	± .003	± .0001	1 PLACE	± .002	± .00005	0 PLACE	± .001	± .00002	DIMENSION STYLE MM/IN DRAWN BY DATE IRIS WANG 1997/5/30 CHECKED BY DATE BEN LEE 1999/2/22 APPROVED BY DATE MISEN 1999/2/22	SCALE 12:1 TITLE SMA JACK STR PCB TH SMA-J/PCB molex DOCUMENT NO. SD-73391-0060 SHEET NO. 1 OF 1
		mm	INCH																			
	4 PLACES	± .005	± .0002																			
	3 PLACES	± .004	± .00015																			
2 PLACES	± .003	± .0001																				
1 PLACE	± .002	± .00005																				
0 PLACE	± .001	± .00002																				
MATERIAL NO. SEE TABLE SIZE C		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION																				
C6		MISEN 1999/2/22																				
REV:		MISEN 1999/2/22																				